

FIG. 1

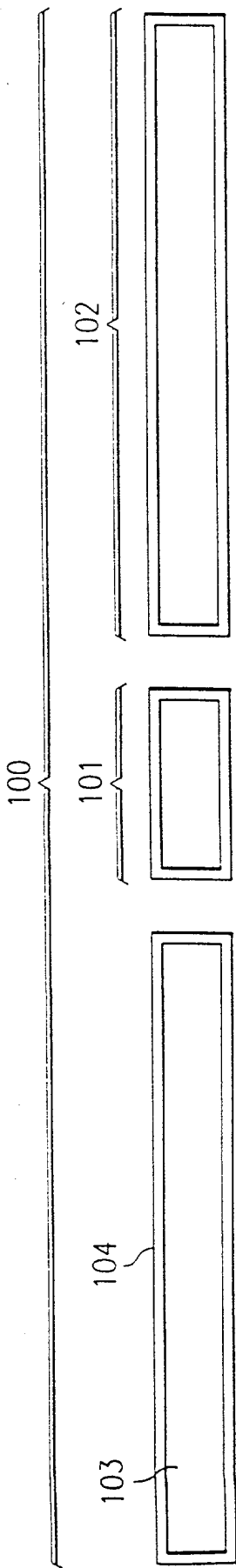


FIG. 2

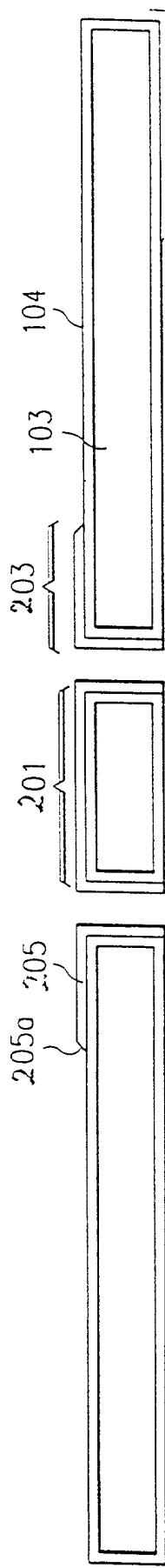
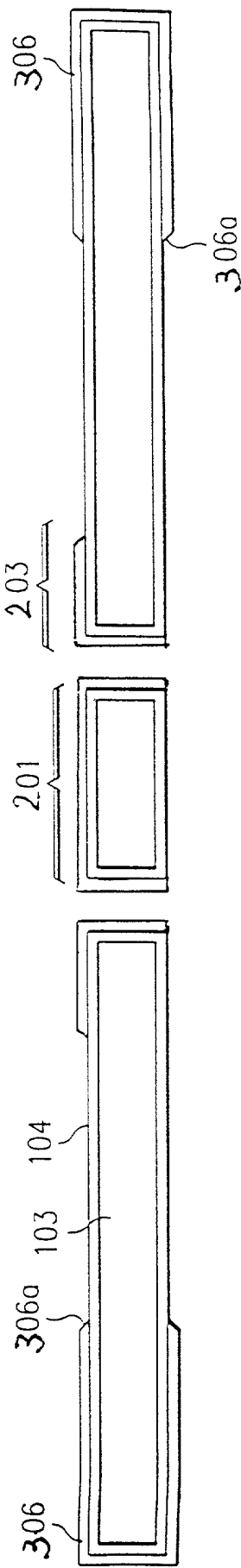


FIG. 3



FIRST PLATING SYSTEM

410

INPUT:  
STAMPED/ETCHED  
LEADFRAME ~411

CLEANING ~412

ACTIVATING ~413

Ni PLATING ~414

SPOT Pd PLATING  
(WHEEL) ~415

RINSING ~416

DRYING ~417

FIG. 4

400

INPUT:  
Ni/Pd PLATED  
LEADFRAME ~421

WETTING ~422

ACTIVATING ~423

COATING RESIST ~424

IMAGING (WHEEL) ~425

DEVELOPING ~426

FLOOD Sn PLATING ~427

STRIPPING RESIST ~428

RINSING ~429

DRYING ~430

OUTPUT:  
Ni, Pd, Sn PLATED  
LEADFRAMES ~431

SECOND PLATING SYSTEM

~420

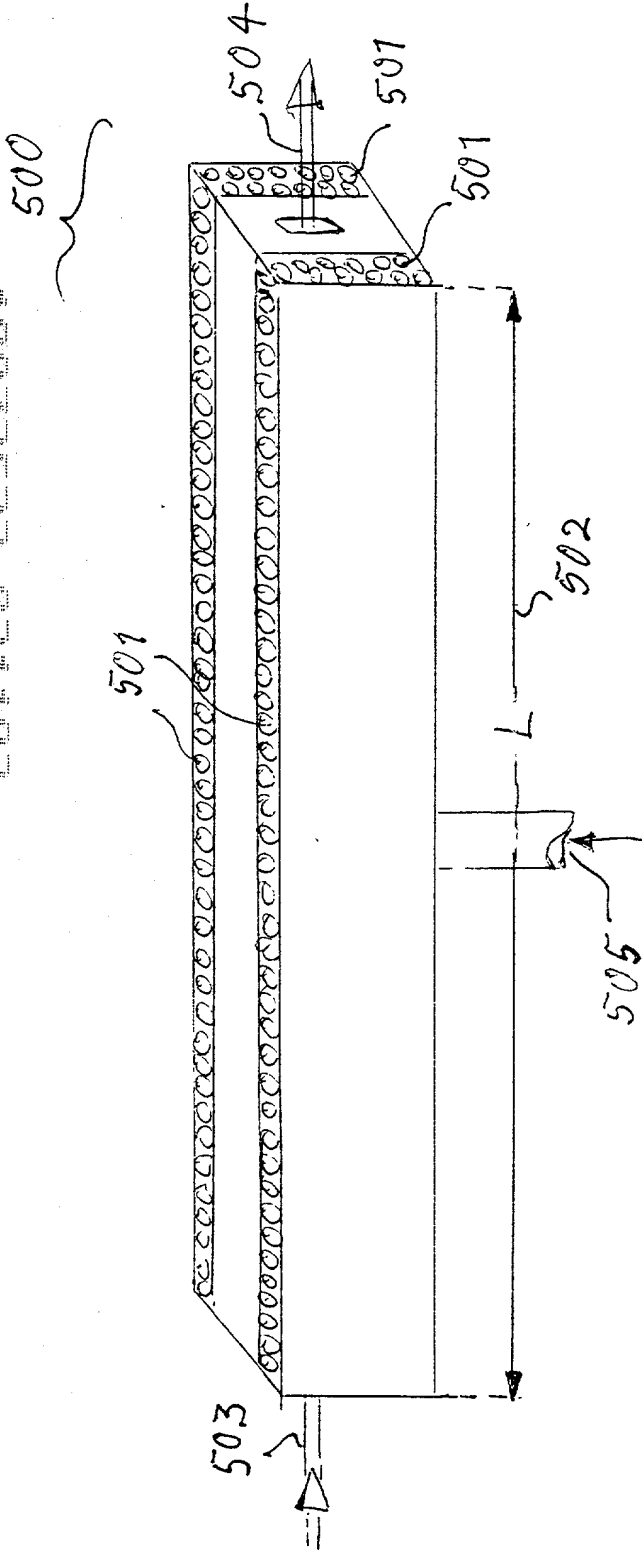


FIG. 5